EFS ID: 3147313 Application Number: 10049270 International Application Number: 9445 Confirmation Number: 9445 Title of Invention: MULTILAYER PRINTED WIRING BOARD, SOLDER RESIST COMPOSITION, METHOD FOR MANUFACTURING MULTILAYER PRINTED WIRING BOARD, AND SEMICONDUCTOR DEVICE First Named Inventor/Applicant Name: Hul Zhong	Electronic Acknowledgement Receipt			
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	Title of Invention:	COMPOSITION, METHOD FOR MANUFACTURING MULTILAYER		
Customer Number:	First Named Inventor/Applicant Name:	Hui Zhong		
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	ocument Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

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If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

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